Silicon Carbide Power Schottky Diode Chip

Features

- 8000 V Silicon Carbide Schottky rectifier
- 175 °C maximum operating temperature
- Positive temperature coefficient of V_F
- · Extremely fast switching speeds
- Superior figure of merit Q_C/I_F



Advantages

- Improved circuit efficiency (Lower overall cost)
- · Low switching losses
- · Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Low reverse recovery current
- · Low device capacitance
- Low reverse leakage current at operating temperature

Maximum Ratings at T_i = 175 °C, unless otherwise specified

| Parameter | Symbol | Conditions | Values | Unit |
|-----------------------------------|---------------------|------------------------|------------|------|
| Repetitive peak reverse voltage | V_{RRM} | | 8000 | V |
| Continuous forward current | I _F | | 50 | mA |
| RMS forward current | I _{F(RMS)} | | 87 | mA |
| Power dissipation | P _{tot} | T _C = 25 °C | 0.2 | W |
| Operating and storage temperature | T_{j} , T_{stg} | | -55 to 175 | °C |

Electrical Characteristics at T_j = 175 °C, unless otherwise specified

| Parameter | Symbol | Conditions | Values | | Unit | |
|-----------------------|---------|--|--------|------|------|-------|
| | | | min. | typ. | max. | Ollit |
| Diode forward voltage | V_{F} | $I_F = 50 \text{ mA}, T_j = 25 ^{\circ}\text{C}$ | | 4.6 | | V |
| | | $I_F = 50 \text{ mA}, T_j = 175 ^{\circ}\text{C}$ | | 12 | | |
| Reverse current | I_{R} | $V_R = 8000 \text{ V}, T_j = 25 ^{\circ}\text{C}$ | | 3.8 | | μΑ |
| Reverse current | | $V_R = 8000 \text{ V}, T_j = 125 ^{\circ}\text{C}$ | | 5.3 | | |
| Total capacitance | С | $V_R = 1 \text{ V, f} = 1 \text{ MHz, T}_j = 25 \text{ °C}$ | | 25 | | |
| | | $V_R = 400 \text{ V}, f = 1 \text{ MHz}, T_j = 25 ^{\circ}\text{C}$ | | 8 | | pF |
| | | $V_R = 1000 \text{ V}, f = 1 \text{ MHz}, T_i = 25 ^{\circ}\text{C}$ | | 6 | | |

^{*}For chip size and metallization, please refer to the mechanical datasheet (must have a non-disclosure agreement with GeneSiC Semiconductor).

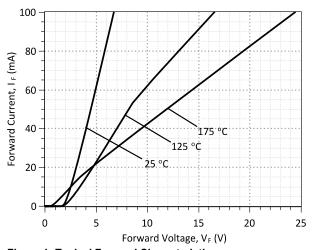


Figure 1: Typical Forward Characteristics

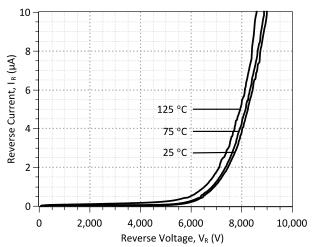


Figure 2: Typical Reverse Characteristics

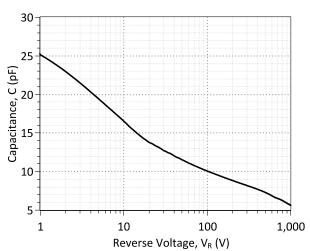


Figure 3: Typical Junction Capacitance vs Reverse Voltage Characteristics

| Revision History | | | | | | |
|------------------|----------|---------------------------|------------|--|--|--|
| Date | Revision | Comments | Supersedes | | | |
| 2013/03/19 | 1 | Added C-V characteristics | | | | |
| 2012/11/28 | 0 | Initial release | | | | |

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SPICE Model Parameters

Copy the following code into a SPICE software program for simulation of the GAP05SLT80_CAL device.

```
MODEL OF GeneSiC Semiconductor Inc.
     $Revision: 1.0
     $Date: 26-AUG-2013
     GeneSiC Semiconductor Inc.
     43670 Trade Center Place Ste. 155
     Dulles, VA 20166
     httphttp://www.genesicsemi.com/index.php/sic-products/schottky
     COPYRIGHT (C) 2013 GeneSiC Semiconductor Inc.
     ALL RIGHTS RESERVED
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
* Start of GAP05SLT80-CAL SPICE Model
.SUBCKT GAP05SLT80 CAL ANODE KATHODE
R1 ANODE INT R=((TEMP-24)*0.81); Temperature Dependant Resistor
D1 INT KATHODE GAP05SLT80 CAL 25C
.MODEL GAP05SLT80 CAL 25C D; Model of GAP05SLT80-CAL Device at 25 C
+ IS
          14.067E-15
          1.3760
+ N
+ RS
          42.6
          157.39E-6
+ IKF
+ EG
          1.2
+ XTI
          -85
+ CJO
         21.838E-12
          0.258
+ M
+ VJ
          3.198
+ BV
          9000
+ IBV
          1E-3
+ TT
          1.0000E-10
+ VPK
          8000
+ IAVE
         3E-2
+ TYPE
          SiC_Schottky
          GeneSiC Semiconductor
+ MFG
.ENDS
* End of GAP05SLT80-CAL SPICE Model
```